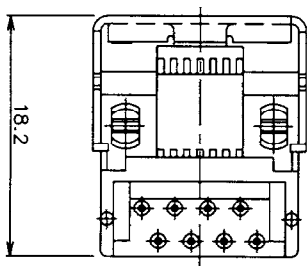
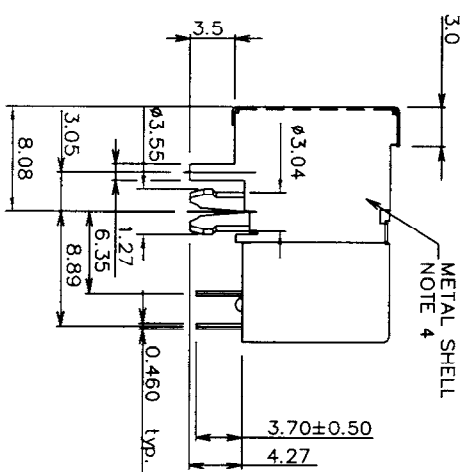
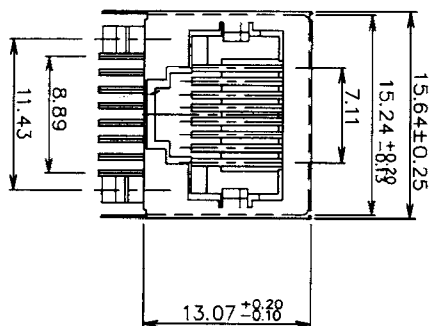
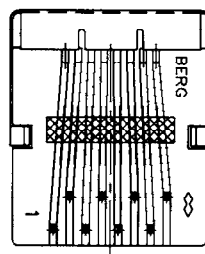
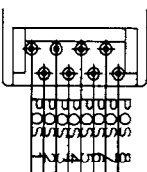


P. C. B. HOLE PATTERN VIEWED FROM TOP.






POS. NO. CONFIGURATION



PRODUCT NO.	NO. OF POSITION	LOADED POSITION
63232-X88	8	ALL POS.
63232-X86		2,3,4,5,6,7
63232-X84		3,4,5,6
63232-X84A		1,2,3,6

PLATING CODE X	PLATING
0	30 μ " GXT
4	15 μ " GXT
6	6 μ " Au
7	GOLD FLASH

mat'l code		tolerance unless otherwise specified		CUSTOMER COPY		 Fci Electronics www.fciconnect.com	
rev.	ech. no.	dr.	date	 projection		title	
A	T85057	JSR	12/27/98	linear		LOW PROFILE PCB III 8-POS	
B	T85023	M WDP/3/3/98		.00 ± 0.15 .0004, 0.05		SEM--SHIELDED MOD JACK	
C	T05034	M WDP/07/00		onques ± .2"		product family MOD JACK	
				 unit		code	
				dr MAGGIE W/DP/15/98		TWN	
				engr TONY CHIEN/09/15/98		sheet	
				chr TONY CHIEN/09/15/98		1 OF 1	
				scale 1 : 1			
				appd JENN TSAO/09/15/98			
sheet revision		C					
index sheet		1					

NOTES:

1. RECOMMENDED P.C.B THICKNESS 1.60 MM
2. HOUSING MAT'L: HIGH TEMP. RESIN,
COLOR: BLACK
3. CONTACTS: COPPER ALLOY
Ø0.46q, ROUND WIRE, PLATING: SEE TABLE.
- ④ METAL SHELL MATERIAL:
BRASS ALLOY, 0.20MM THICK,
FINISH: TIN-LEAD PLATING
5. PACKAGING: USING TUBE.